# CRMKGL0304A

### N-Channel 30V, 4mΩ Typ. Power MOSFET

## **Description**

### **Features**

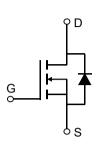
• 30V, 75A

$$R_{DS(ON)}$$
 Typ =  $4m\Omega$  @  $V_{GS}$  =  $10V$   
 $R_{DS(ON)}$  Typ =  $5.6m\Omega$  @  $V_{GS}$  =  $4.5V$ 

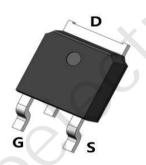
- Advanced Split Gate Trench Technology
- Excellent R<sub>DS(ON)</sub> and Low Gate Charge
- 100% UIS TESTED!
- 100% ΔVds TESTED!

# **Application**

- Load Switch
- PWM Application
- Power Management









Initial Version: 1.0

#### **Marking and Pin Assignment**

### Package Marking and Ordering Information

Device	Marking	Package	Outline	Reel Size	Reel (pcs)	Per Carton (pcs)
CRMKGL0304A	CRMKGL0304A	TO-252-3L	TAPING	13"	2500	25000

### Absolute Maximum Ratings (@ T<sub>J</sub> = 25°C unless otherwise specified)

Symbol	Parameter		Value	Units
$V_{DS}$	Drain-to-Source Voltage		30	V
$V_{GS}$	Gate-to-Source Voltage		±20	V
	Continuous Drain Current	T <sub>C</sub> = 25°C	75	А
I <sub>D</sub>		T <sub>C</sub> = 100°C	45	А
I <sub>DM</sub>	Pulsed Drain Current (1)		300	Α
E <sub>AS</sub>	Single Pulsed Avalanche Energy (2)		56	mJ
$P_{D}$	Power Dissipation	T <sub>C</sub> = 25°C	50	W
$R_{ heta JC}$	Thermal Resistance, Junction to Case		2.5	°C/W
$T_{J}, T_{STG}$	Junction & Storage Temperature Range		-55 to 150	°C

# CRMKGL0304A

# N-Channel 30V, $4m\Omega$ Typ. Power MOSFET

## **Electrical Characteristics** (T<sub>J</sub> = 25°C unless otherwise specified)

Symbol	Parameter	Conditions	Min.	Тур.	Max.	Unit
Off Chara	acteristics					
V <sub>(BR)DSS</sub>	Drain-Source Breakdown Voltage	$I_D = 250 \mu A, V_{GS} = 0 V$	30	-	-	V
I <sub>DSS</sub>	Zero Gate Voltage Drain Current	$V_{DS} = 30V, V_{GS} = 0V$	-	-	1.0	μА
I <sub>GSS</sub>	Gate-Body Leakage Current	$V_{DS} = 0V, V_{GS} = \pm 20V$	-	-	±100	nA
On Chara	acteristics				G	
$V_{GS(th)}$	Gate Threshold Voltage	$V_{DS} = V_{GS}, I_{D} = 250 \mu A$	1	1.5	2.5	V
R <sub>DS(ON)</sub>	Static Drain-Source ON-Resistance <sup>(3)</sup>	$V_{GS} = 10V, I_D = 20A$	-	4	5.2	mΩ
		$V_{GS} = 4.5V, I_D = 10A$	-	5.6	7.3	mΩ
Dynamic	Characteristics					
$C_{iss}$	Input Capacitance			953	-	pF
$C_{oss}$	Output Capacitance	$V_{GS} = 0V, V_{DS} = 15V,$ f = 1MHz	X-\	446	-	pF
$C_{rss}$	Reverse Transfer Capacitance	1 - 1101112	- 1	34	-	pF
$Q_g$	Total Gate Charge		<b>J</b> -	17	-	nC
$Q_gs$	Gate Source Charge	$V_{GS} = 0 \text{ to } 10V$ $V_{DS} = 20V, I_{D} = 50A$	-	4.5	-	nC
$Q_{gd}$	Gate Drain("Miller") Charge	V <sub>DS</sub> = 20 V, I <sub>D</sub> = 00/1	-	2	-	nC
Switchin	g Characteristics					
$t_{d(on)}$	Turn-On DelayTime		-	6.5	-	ns
$t_r$	Turn-On Rise Time	$V_{GS} = 10V, V_{DD} = 20V$	-	2.7	-	ns
$t_{\text{d(off)}}$	Turn-Off DelayTime	$I_D = 50A$ , $R_{GEN} = 3\Omega$	-	26	-	ns
$t_f$	Turn-Off Fall Time		-	3.6	-	ns
Drain-So	urce Diode Characteristics and M	Max Ratings				
Is	Maximum Continuous Drain to Source Diode Forward Current		-	-	75	Α
I <sub>SM</sub>	Maximum Pulsed Drain to Source Diode	Forward Current	-	-	300	Α
V <sub>SD</sub>	Drain to Source Diode Forward Voltage	V <sub>GS</sub> = 0V, I <sub>S</sub> = 10A	-	-	1.2	V
trr	Body Diode Reverse Recovery Time	1 - 504 di/dt - 1004/:	-	22	-	ns
Qrr	Body Diode Reverse Recovery Charge	$I_F = 50A$ , di/dt = 100A/us	-	40	-	nC
	T T T T T T T T T T T T T T T T T T T					

Notes:

<sup>1.</sup> Repetitive Rating: Pulse Width Limited by Maximum Junction Temperature.

<sup>2.</sup>  $E_{AS}$  condition: Starting  $T_J$ =25°C,  $V_{DD}$ =30V,  $V_G$ =10V,  $R_G$ =25ohm, L=0.5mH,  $I_{AS}$ =15A

<sup>3.</sup> Pulse Test: Pulse Width≤300µs, Duty Cycle≤0.5%.

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## **Test Circuit**

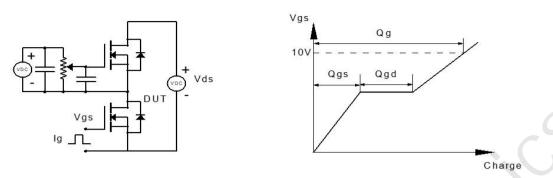


Figure 1: Gate Charge Test Circuit & Waveform

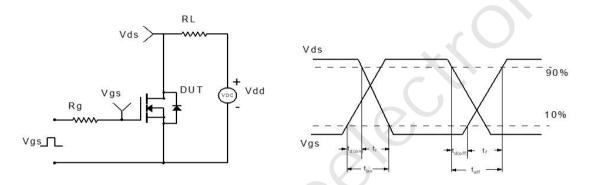


Figure 2: Resistive Switching Test Circuit & Waveform

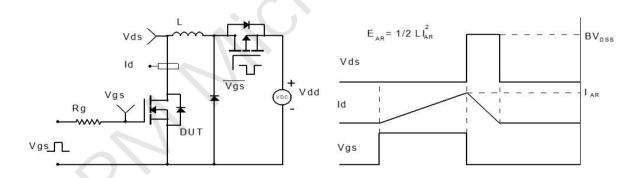


Figure 3: Unclamped Inductive Switching Test Circuit& Waveform

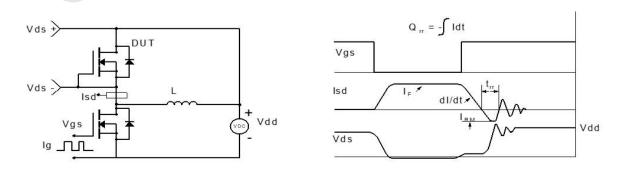
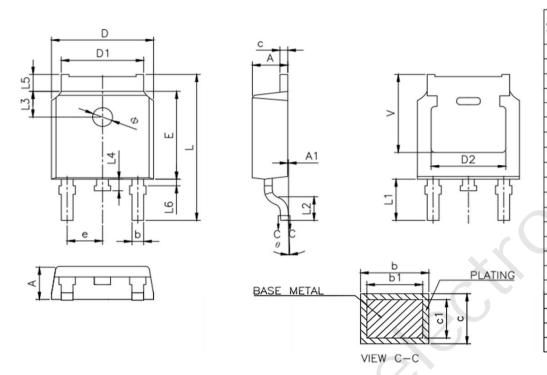


Figure 4: Diode Recovery Test Circuit & Waveform

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## Package Mechanical Data(TO-252-3L)



SYMBOL	MILLIMETER				
STWIDOL	MIN NOM		MAX		
Α	2.20	2.30	2.40		
A1	0.00		0.127		
b	0.66		0.86		
b1	0.65	0.76	0.81		
D	6.50	6.60	6.70		
D1	5.10	5.33	5.46		
С	0.47		0.60		
c1	0.46	0.51	0.56		
D2	4.83 REF.				
Е	6.00	6.10	6.20		
е	2.186	2.286	2.386		
L	9.80 10.10		10.40		
L1	2.90 REF.				
L2	1.40	1.50	1.60		
L3	1.80 REF.				
L4	0.60	0.80	1.00		
L5	0.90		1.25		
L6	0.15		0.75		
Φ	1.10		1.30		
θ	0.		8.		
V	5.40 REF				

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## **Contact information**

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